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NEXCHIP SEMICONDUCTOR CORPORATION

合肥晶合集成电路股份有限公司

(A joint stock company incorporated in the People's Republic of China with limited liability)

(Stock Code: 2249)

CHANGE OF ENGLISH CORPORATE NAME

Reference is made to the prospectus of the Company dated June 30, 2026 (the “**Prospectus**”). As disclosed in the Prospectus, the Company has submitted an application to the Registrar of Companies in Hong Kong on June 8, 2026 to change its English corporate name registered in Hong Kong from “Nexchip Semiconductor (China) Limited” to “Nexchip Semiconductor Corporation”.

Unless otherwise defined in this announcement, capitalized terms used herein shall have the same meanings as those defined in the Prospectus.

CHANGE OF ENGLISH CORPORATE NAME

The board of directors (the “**Board**”) of the Company is pleased to announce that on July 6, 2026, the Registrar of Companies in Hong Kong issued the Certificate of Registration of Alteration of Name of Registered Non-Hong Kong Company, which confirmed that under Part 16 of the Companies Ordinance (Chapter 622 of the laws of Hong Kong), the Company has altered its name and is now registered under the English corporate name of “Nexchip Semiconductor Corporation”.

EFFECT OF THE CHANGE OF ENGLISH CORPORATE NAME

The change of English corporate name of the Company in Hong Kong will not affect any of the rights of the shareholders of the Company. All H Share certificates of the Company to be issued bearing the former name of “Nexchip Semiconductor (China) Limited” shall continue to be effective as evidence of title and valid for trading, settlement, delivery and registration purposes. Accordingly, there will not be any arrangement for free exchange of H Share certificates of the Company to be issued prior to the Listing for new H Share certificates bearing the Company’s new English corporate name.

Following the change of English corporate name of the Company in Hong Kong, the English and Chinese stock short names of the Company for trading in the H Shares on the Stock Exchange will remain unchanged as “NEXCHIP” and “晶合集成” respectively, and the stock code of the H Shares will remain unchanged as 2249.

By order of the Board
Nexchip Semiconductor Corporation
合肥晶合集成電路股份有限公司

Mr. Tsai Kuo-Chih
Executive Director and chairperson of the Board

Hong Kong, July 7, 2026

As at the date of this announcement, the Board comprises: (i) Mr. Tsai Kuo-Chih and Mr. Zhu Caiwei as Executive Directors; (ii) Mr. Lu Qinhang, Ms. Chen Xiaobei, Mr. Guo Zhaozhi and Mr. Qiu Wensheng as Non-executive Directors; and (iii) Prof. An Guangshi, Prof. Lin Zhiting and Mr. Chen Ting as Independent non-executive Directors.